

<i>flowPIM 0</i>	600V/6A
<div style="border: 1px solid black; padding: 5px; margin-bottom: 5px;"> <p style="text-align: center; background-color: #000080; color: white; margin: 0;"><b>Features</b></p> <ul style="list-style-type: none"> <li>Clip-in housing</li> <li>Trench Fieldstop IGBT's for low saturation losses</li> <li>Optional w/o BRC</li> </ul> </div> <div style="border: 1px solid black; padding: 5px; margin-bottom: 5px;"> <p style="text-align: center; background-color: #000080; color: white; margin: 0;"><b>Target Applications</b></p> <ul style="list-style-type: none"> <li>Industrial drives</li> <li>Embedded drives</li> </ul> </div> <div style="border: 1px solid black; padding: 5px;"> <p style="text-align: center; background-color: #000080; color: white; margin: 0;"><b>Types</b></p> <ul style="list-style-type: none"> <li>V23990-P541-A38-PM</li> <li>V23990-P541-A39-PM</li> <li>V23990-P541-C38-PM</li> <li>V23990-P541-C39-PM</li> </ul> </div>	<div style="border: 1px solid black; padding: 5px; margin-bottom: 5px;"> <p style="text-align: center; background-color: #000080; color: white; margin: 0;"><b>flowPIM 0 housing</b></p> <div style="display: flex; justify-content: space-around; align-items: center;"> </div> <div style="display: flex; justify-content: space-around; align-items: center; font-size: small;"> <span>12mm housing</span> <span>17mm housing</span> </div> </div> <div style="border: 1px solid black; padding: 5px;"> <p style="text-align: center; background-color: #000080; color: white; margin: 0;"><b>Schematic</b></p> </div>

## Maximum Ratings

$T_j=25^\circ\text{C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
<b>Input Rectifier Diode</b>				
Repetitive peak reverse voltage	$V_{RRM}$		1600	V
DC forward current	$I_{FAV}$	$T_j=T_{jmax}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	33 46	A
Surge forward current	$I_{FSM}$	$t_p=10\text{ms}$ 50Hz half sine wave $T_j=25^\circ\text{C}$	250	A
I2t-value	$I^2t$		310	$\text{A}^2\text{s}$
Power dissipation per Diode	$P_{tot}$	$T_j=T_{jmax}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	37 59	W
Maximum Junction Temperature	$T_{jmax}$		150	$^\circ\text{C}$
<b>Inverter Transistor</b>				
Collector-emitter break down voltage	$V_{CE}$		600	V
DC collector current	$I_C$	$T_j=T_{jmax}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	12 12	A
Repetitive peak collector current	$I_{Cpulse}$	$t_p$ limited by $T_{jmax}$	18	A
Turn off safe operating area		$V_{CE} \leq 600\text{V}$ , $T_j \leq T_{jmax}$	18	A
Power dissipation per IGBT	$P_{tot}$	$T_j=T_{jmax}$ $T_h=80^\circ\text{C}$ $T_c=80^\circ\text{C}$	34 52	W
Gate-emitter peak voltage	$V_{GE}$		$\pm 20$	V
Short circuit ratings	$t_{SC}$ $V_{CC}$	$T_j \leq 150^\circ\text{C}$ $V_{GE} = 15\text{V}$	6 360	$\mu\text{s}$ V
Maximum Junction Temperature	$T_{jmax}$		175	$^\circ\text{C}$

## Maximum Ratings

 $T_j=25^{\circ}\text{C}$ , unless otherwise specified

Parameter	Symbol	Condition	Value	Unit
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### Inverter Diode

Peak Repetitive Reverse Voltage	$V_{RRM}$		600	V
DC forward current	$I_F$	$T_j=T_{jmax}$	$T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$	12 12
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	12	A
Power dissipation per Diode	$P_{tot}$	$T_j=T_{jmax}$	$T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$	26 39
Maximum Junction Temperature	$T_{jmax}$		175	$^{\circ}\text{C}$

### Brake Transistor

Collector-emitter break down voltage	$V_{CE}$		600	V
DC collector current	$I_C$	$T_j=T_{jmax}$	$T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$	11 12
Repetitive peak collector current	$I_{Cpuls}$	$t_p$ limited by $T_{jmax}$	18	A
Turn off safe operating area		$V_{CE} \leq 600\text{V}$ , $T_j \leq T_{op max}$	18	A
Power dissipation per IGBT	$P_{tot}$	$T_j=T_{jmax}$	$T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$	31 47
Gate-emitter peak voltage	$V_{GE}$		$\pm 20$	V
Short circuit ratings	$t_{SC}$ $V_{CC}$	$T_j \leq 150^{\circ}\text{C}$ $V_{GE} = 15\text{V}$	6 360	$\mu\text{s}$ V
Maximum Junction Temperature	$T_{jmax}$		175	$^{\circ}\text{C}$

### Brake Diode

Peak Repetitive Reverse Voltage	$V_{RRM}$		600	V
DC forward current	$I_F$	$T_j=T_{jmax}$	$T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$	11 12
Repetitive peak forward current	$I_{FRM}$	$t_p$ limited by $T_{jmax}$	12	A
Power dissipation per Diode	$P_{tot}$	$T_j=T_{jmax}$	$T_h=80^{\circ}\text{C}$ $T_c=80^{\circ}\text{C}$	23 35
Maximum Junction Temperature	$T_{jmax}$		175	$^{\circ}\text{C}$

### Thermal Properties

Storage temperature	$T_{slg}$		-40...+125	$^{\circ}\text{C}$
Operation temperature under switching condition	$T_{op}$		-40...+( $T_{jmax} - 25$ )	$^{\circ}\text{C}$

### Insulation Properties

Insulation voltage	$V_{is}$	$t=2\text{s}$ DC voltage	4000	V
Creepage distance			min 12,7	mm
Clearance			min 12,7	mm
Comparative tracking index	CTI		>200	

**Characteristic Values**

Parameter	Symbol	Conditions					Value			Unit
		$V_{GE}[V]$ or $V_{GS}[V]$	$V_r[V]$ or $V_{CE}[V]$ or $V_{DS}[V]$	$I_c[A]$ or $I_F[A]$ or $I_b[A]$	$T_j$	Min	Typ	Max		
<b>Input Rectifier Diode</b>										
Forward voltage	$V_F$				30	$T_j=25^\circ C$ $T_j=125^\circ C$	0,8	1,16 1,13	1,6	V
Threshold voltage (for power loss calc. only)	$V_{to}$				30	$T_j=25^\circ C$ $T_j=125^\circ C$		0,90 0,78		V
Slope resistance (for power loss calc. only)	$r_t$				30	$T_j=25^\circ C$ $T_j=125^\circ C$		8 11		m $\Omega$
Reverse current	$I_r$			1500		$T_j=25^\circ C$ $T_j=150^\circ C$			2	mA
Thermal resistance chip to heatsink per chip	$R_{thJH}$	Thermal grease thickness $\leq$ 50um $\lambda = 1$ W/mK						1,89		K/W
<b>Inverter Transistor</b>										
Gate emitter threshold voltage	$V_{GE(th)}$	$V_{CE}=V_{GE}$			0,00009	$T_j=25^\circ C$ $T_j=150^\circ C$	5	5,8	6,5	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		6	$T_j=25^\circ C$ $T_j=150^\circ C$	1	1,52 1,7	2,1	V
Collector-emitter cut-off current incl. Diode	$I_{CES}$		0	600		$T_j=25^\circ C$ $T_j=150^\circ C$			0,06	mA
Gate-emitter leakage current	$I_{GES}$		20	0		$T_j=25^\circ C$ $T_j=150^\circ C$			350	nA
Integrated Gate resistor	$R_{gint}$							none		$\Omega$
Turn-on delay time	$t_{d(on)}$	$R_{goff}=16 \Omega$ $R_{gon}=32 \Omega$	$\pm 15$	300	6	$T_j=25^\circ C$ $T_j=150^\circ C$		12 10		ns
Rise time	$t_r$					$T_j=25^\circ C$ $T_j=150^\circ C$		8 11		
Turn-off delay time	$t_{d(off)}$					$T_j=25^\circ C$ $T_j=150^\circ C$		118 134		
Fall time	$t_f$					$T_j=25^\circ C$ $T_j=150^\circ C$		87 116		
Turn-on energy loss per pulse	$E_{on}$					$T_j=25^\circ C$ $T_j=150^\circ C$		0,07 0,10		
Turn-off energy loss per pulse	$E_{off}$	$T_j=25^\circ C$ $T_j=150^\circ C$		0,15 0,19						
Input capacitance	$C_{ies}$	$f=1$ MHz	0	25		$T_j=25^\circ C$		368		pF
Output capacitance	$C_{oss}$							28		
Reverse transfer capacitance	$C_{rss}$							11		
Gate charge	$Q_{Gate}$		$\pm 15$	480	6	$T_j=25^\circ C$		42		nC
Thermal resistance chip to heatsink per chip	$R_{thJH}$	Thermal grease thickness $\leq$ 50um $\lambda = 1$ W/mK						2,78		K/W
<b>Inverter Diode</b>										
Diode forward voltage	$V_F$				6	$T_j=25^\circ C$ $T_j=150^\circ C$	1	1,64 1,56	2,5	V
Peak reverse recovery current	$I_{RRM}$	$R_{gon}=32 \Omega$	$\pm 15$	300	6	$T_j=25^\circ C$ $T_j=150^\circ C$		8 8		A
Reverse recovery time	$t_{rr}$					$T_j=25^\circ C$ $T_j=150^\circ C$		73 163		
Reverse recovered charge	$Q_{rr}$					$T_j=25^\circ C$ $T_j=150^\circ C$		0,23 0,43		$\mu C$
Peak rate of fall of recovery current	$di(rec)max/dt$					$T_j=25^\circ C$ $T_j=150^\circ C$		569 338		
Reverse recovered energy	$E_{rec}$					$T_j=25^\circ C$ $T_j=150^\circ C$		0,04 0,09		mWs
Thermal resistance chip to heatsink per chip	$R_{thJH}$	Thermal grease thickness $\leq$ 50um $\lambda = 1$ W/mK						3,68		K/W

**Characteristic Values**

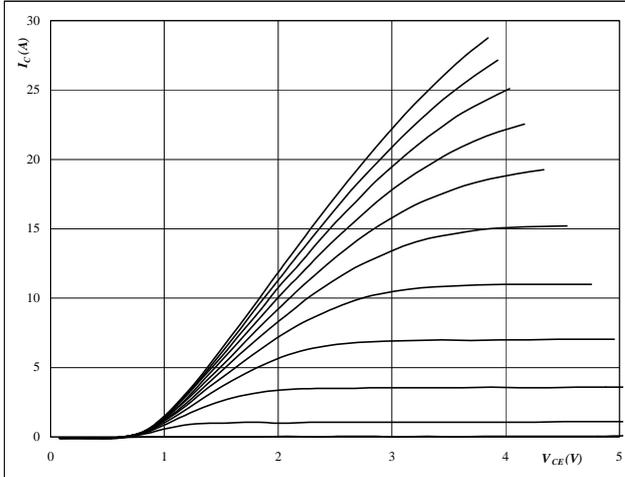
Parameter	Symbol	Conditions					Value			Unit
		$V_{GE}[V]$ or $V_{GS}[V]$	$V_r[V]$ or $V_{CE}[V]$ or $V_{DS}[V]$	$I_c[A]$ or $I_F[A]$ or $I_D[A]$	$T_j$	Min	Typ	Max		
<b>Brake Transistor</b>										
Gate emitter threshold voltage	$V_{GE(th)}$	$V_{CE}=V_{GE}$			0,00009	$T_j=25^\circ C$ $T_j=150^\circ C$	5	5,8	6,5	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		30	$T_j=25^\circ C$ $T_j=150^\circ C$	1	1,54 1,72	2,1	V
Collector-emitter cut-off incl diode	$I_{CES}$		0	600		$T_j=25^\circ C$ $T_j=150^\circ C$			0,06	mA
Gate-emitter leakage current	$I_{GES}$		20	0		$T_j=25^\circ C$ $T_j=150^\circ C$			350	nA
Integrated Gate resistor	$R_{gint}$							none		$\Omega$
Turn-on delay time	$t_{d(on)}$	$R_{goff}=16 \Omega$ $R_{gon}=32 \Omega$	$\pm 15$	300	6	$T_j=25^\circ C$		11		ns
Rise time	$t_r$					$T_j=150^\circ C$		11		
Turn-off delay time	$t_{d(off)}$					$T_j=25^\circ C$		8		
Fall time	$t_f$					$T_j=150^\circ C$		11		
Turn-on energy loss per pulse	$E_{on}$					$T_j=25^\circ C$		112		
Turn-off energy loss per pulse	$E_{off}$	$T_j=150^\circ C$	127							
Input capacitance	$C_{ies}$	f=1MHz	0	25		$T_j=25^\circ C$		0,08		pF
Output capacitance	$C_{oss}$							0,11		
Reverse transfer capacitance	$C_{rss}$							0,14 0,17		
Gate charge	$Q_{Gate}$		$\pm 15$	480	6	$T_j=25^\circ C$		42		nC
Thermal resistance chip to heatsink per chip	$R_{thJH}$	Thermal grease thickness $\leq 50\mu m$ $\lambda = 1 W/mK$						3,06		K/W
<b>Brake Diode</b>										
Diode forward voltage	$V_F$				6	$T_j=25^\circ C$ $T_j=150^\circ C$	1	1,63 1,56	2,5	V
Reverse leakage current	$I_r$	$R_{gon}=32 \Omega$		600		$T_j=25^\circ C$ $T_j=150^\circ C$			60	$\mu A$
Peak reverse recovery current	$I_{RRM}$	$R_{gon}=32 \Omega$	$\pm 15$	300	6	$T_j=25^\circ C$		7		A
Reverse recovery time	$t_{rr}$					$T_j=150^\circ C$		7		
Reverse recovered charge	$Q_{rr}$					$T_j=25^\circ C$		96		
Peak rate of fall of recovery current	$di(rec)max/dt$					$T_j=150^\circ C$		165		
Reverse recovery energy	$E_{rec}$					$T_j=25^\circ C$		0,23		
		$T_j=150^\circ C$	0,23							
		$T_j=25^\circ C$	442							
		$T_j=150^\circ C$	268							
		$T_j=25^\circ C$	0,04							
		$T_j=150^\circ C$	0,09							
Thermal resistance chip to heatsink per chip	$R_{thJH}$	Thermal grease thickness $\leq 50\mu m$ $\lambda = 1 W/mK$						4,09		K/W
<b>Thermistor</b>										
Rated resistance	R					$T=25^\circ C$		22000		$\Omega$
Deviation of R100	$\Delta R/R$	R100=1486 $\Omega$				$T=100^\circ C$	-5		5	%
Power dissipation	P					$T=25^\circ C$		210		mW
Power dissipation constant						$T=25^\circ C$		3,5		mW/K
B-value	$B_{(25/50)}$	Tol. $\pm 3\%$				$T=25^\circ C$				K
B-value	$B_{(25/100)}$	Tol. $\pm 3\%$				$T=25^\circ C$		4000		K
Vincotech NTC Reference									A	

## Output Inverter

Figure 1 Output inverter IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

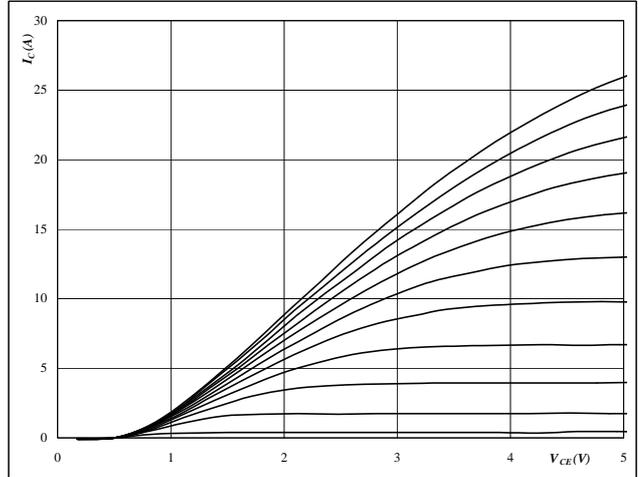


At  
 $t_p = 250 \mu s$   
 $T_J = 25 \text{ }^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

Figure 2 Output inverter IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

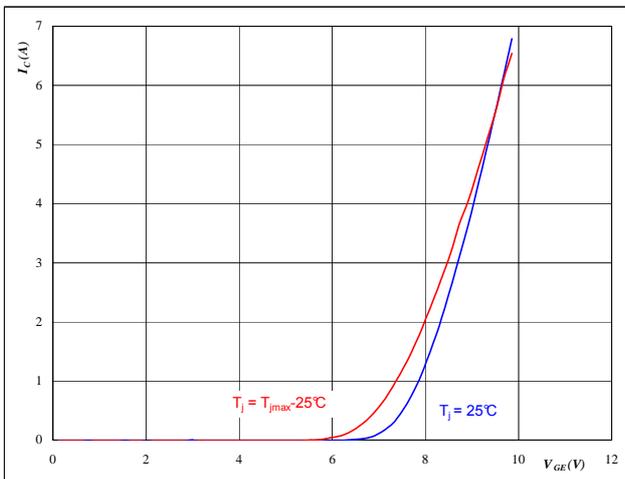


At  
 $t_p = 250 \mu s$   
 $T_J = 125 \text{ }^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

Figure 3 Output inverter IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

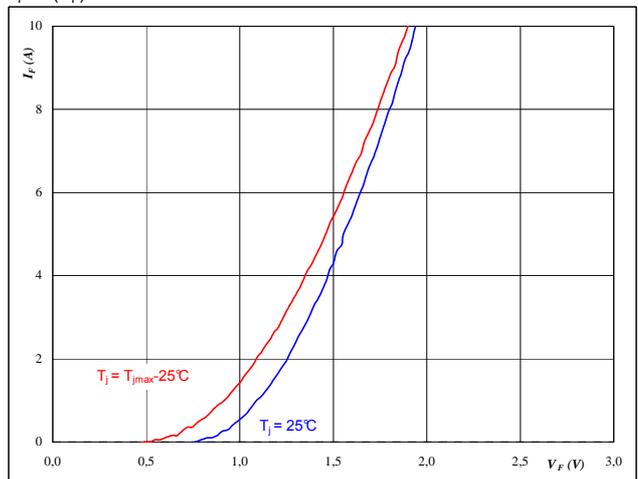


At  
 $t_p = 250 \mu s$   
 $V_{CE} = 10 \text{ V}$

Figure 4 Output inverter FWD

Typical diode forward current as a function of forward voltage

$$I_F = f(V_F)$$



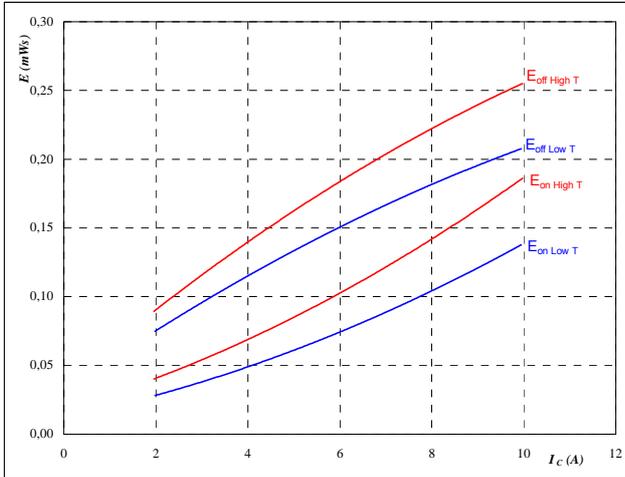
At  
 $t_p = 250 \mu s$

## Output Inverter

**Figure 5** Output inverter IGBT

**Typical switching energy losses as a function of collector current**

$$E = f(I_C)$$



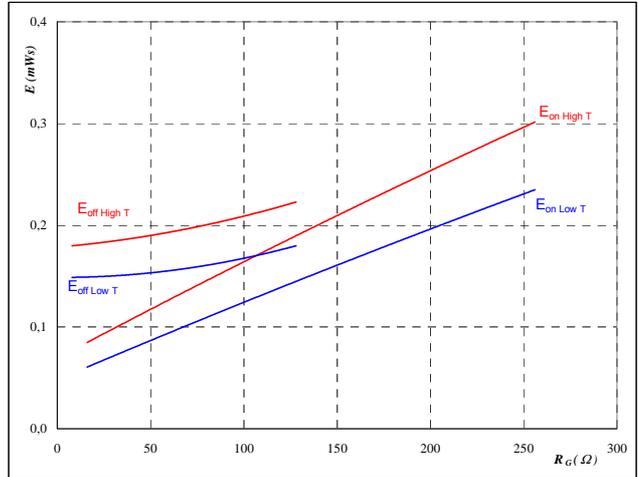
With an inductive load at

$T_J =$	25/125	°C
$V_{CE} =$	300	V
$V_{GE} =$	15	V
$R_{gon} =$	32	Ω
$R_{goff} =$	16	Ω

**Figure 6** Output inverter IGBT

**Typical switching energy losses as a function of gate resistor**

$$E = f(R_G)$$



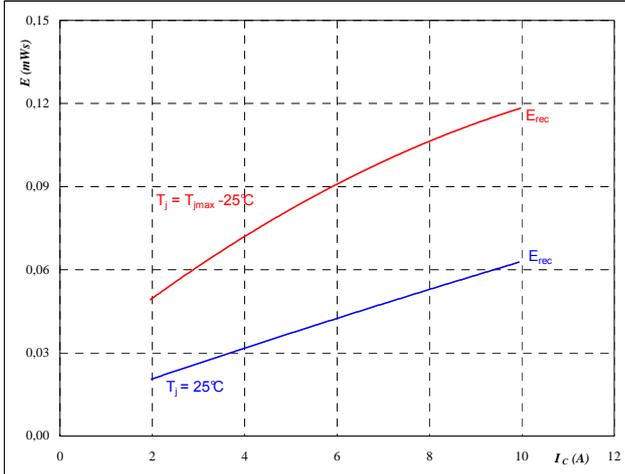
With an inductive load at

$T_J =$	25/125	°C
$V_{CE} =$	300	V
$V_{GE} =$	15	V
$I_C =$	6	A

**Figure 7** Output inverter FWD

**Typical reverse recovery energy loss as a function of collector current**

$$E_{rec} = f(I_C)$$



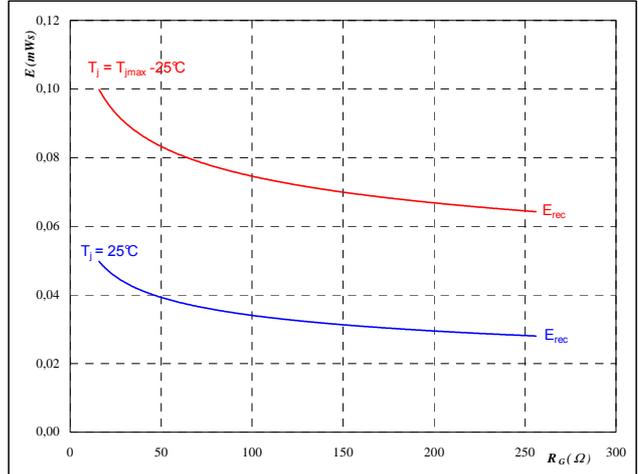
With an inductive load at

$T_J =$	25/125	°C
$V_{CE} =$	300	V
$V_{GE} =$	15	V
$R_{gon} =$	32	Ω

**Figure 8** Output inverter FWD

**Typical reverse recovery energy loss as a function of gate resistor**

$$E_{rec} = f(R_G)$$



With an inductive load at

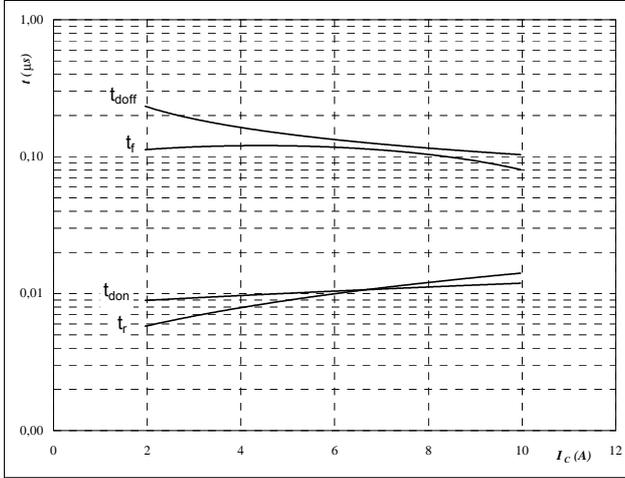
$T_J =$	25/125	°C
$V_{CE} =$	300	V
$V_{GE} =$	15	V
$I_C =$	6	A

## Output Inverter

Figure 9 Output inverter IGBT

Typical switching times as a function of collector current

$t = f(I_C)$



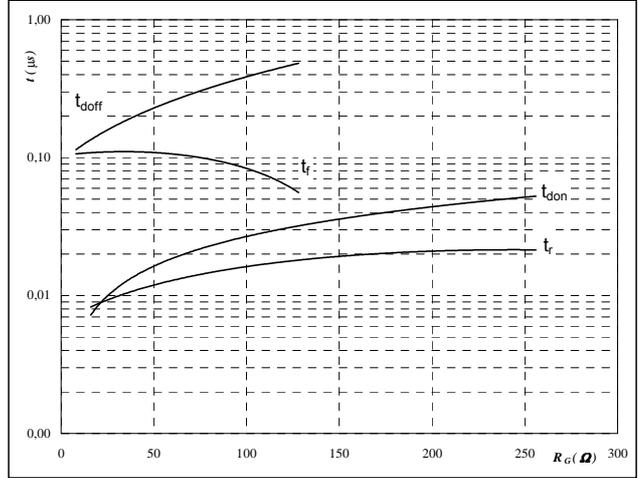
With an inductive load at

$T_J =$	125	°C
$V_{CE} =$	300	V
$V_{GE} =$	15	V
$R_{gon} =$	32	Ω
$R_{goff} =$	16	Ω

Figure 10 Output inverter IGBT

Typical switching times as a function of gate resistor

$t = f(R_G)$



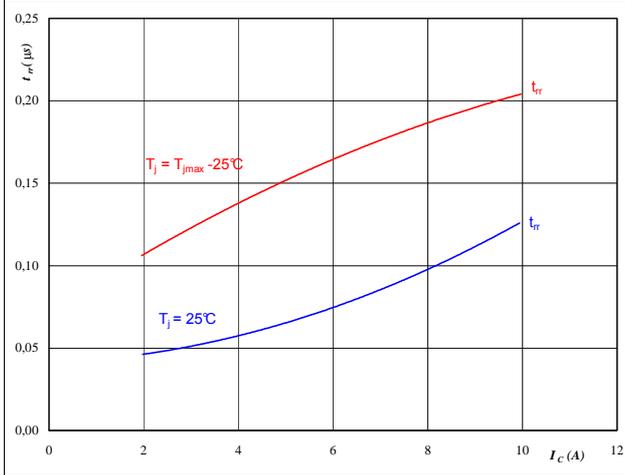
With an inductive load at

$T_J =$	125	°C
$V_{CE} =$	300	V
$V_{GE} =$	15	V
$I_C =$	6	A

Figure 11 Output inverter FWD

Typical reverse recovery time as a function of collector current

$t_{rr} = f(I_C)$



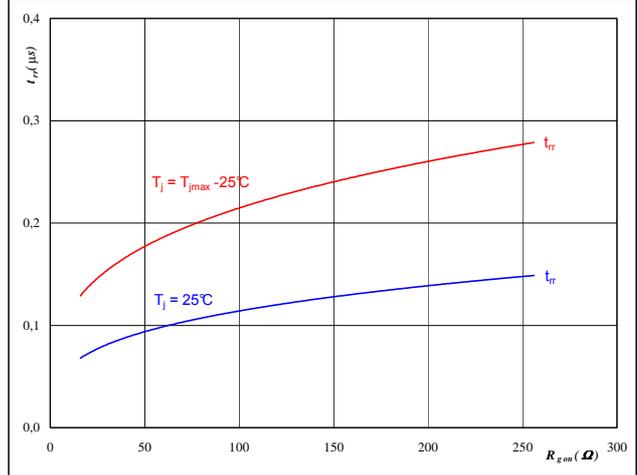
At

$T_J =$	25/125	°C
$V_{CE} =$	300	V
$V_{GE} =$	15	V
$R_{gon} =$	32	Ω

Figure 12 Output inverter FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor

$t_{rr} = f(R_{gon})$



At

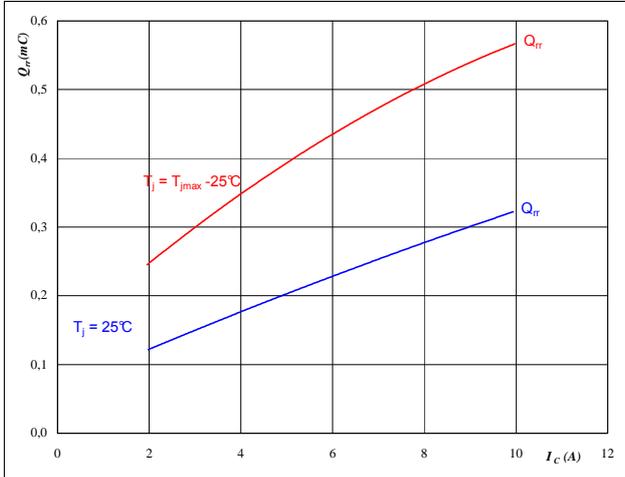
$T_J =$	25/125	°C
$V_R =$	300	V
$I_F =$	6	A
$V_{GE} =$	15	V

## Output Inverter

Figure 13 Output inverter FWD

Typical reverse recovery charge as a function of collector current

$$Q_{rr} = f(I_C)$$



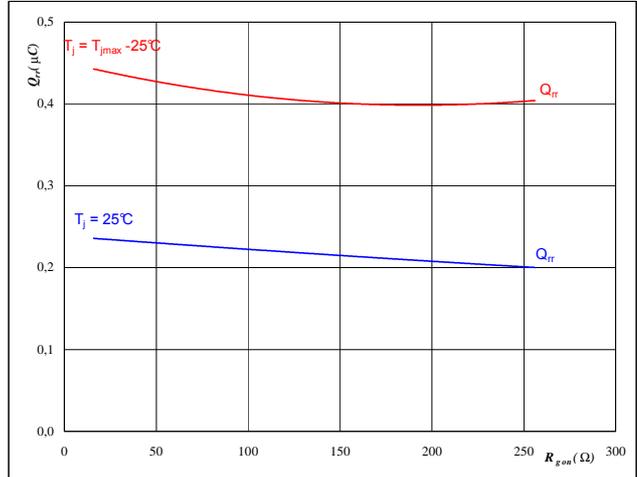
At

$T_j = 25/125$  °C  
 $V_{CE} = 300$  V  
 $V_{GE} = 15$  V  
 $R_{gon} = 32$  Ω

Figure 14 Output inverter FWD

Typical reverse recovery charge as a function of IGBT turn on gate resistor

$$Q_{rr} = f(R_{gon})$$



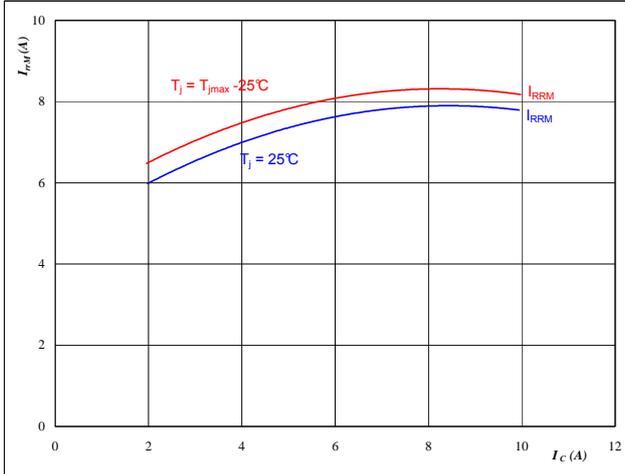
At

$T_j = 25/125$  °C  
 $V_R = 300$  V  
 $I_F = 6$  A  
 $V_{GE} = 15$  V

Figure 15 Output inverter FWD

Typical reverse recovery current as a function of collector current

$$I_{RRM} = f(I_C)$$



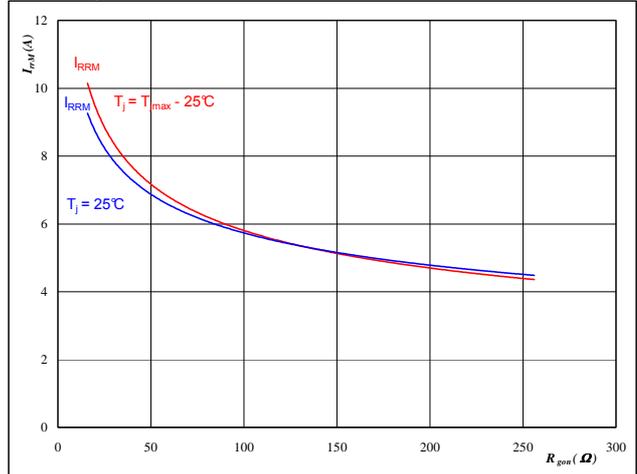
At

$T_j = 25/125$  °C  
 $V_{CE} = 300$  V  
 $V_{GE} = 15$  V  
 $R_{gon} = 32$  Ω

Figure 16 Output inverter FWD

Typical reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RRM} = f(R_{gon})$$



At

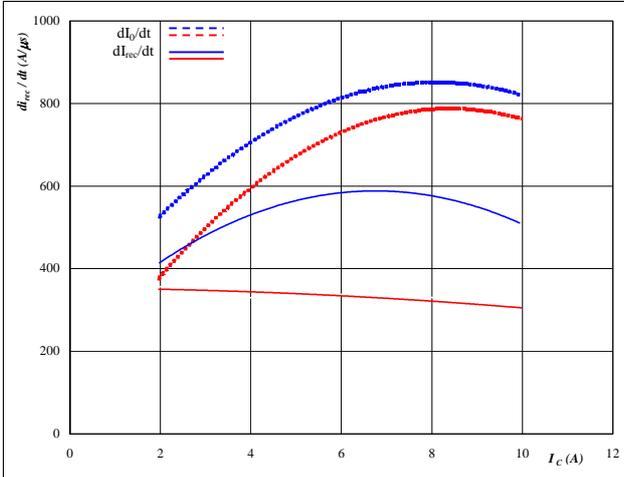
$T_j = 25/125$  °C  
 $V_R = 300$  V  
 $I_F = 6$  A  
 $V_{GE} = 15$  V

## Output Inverter

Figure 17 Output inverter FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current

$$dI_f/dt, dI_{rec}/dt = f(I_C)$$

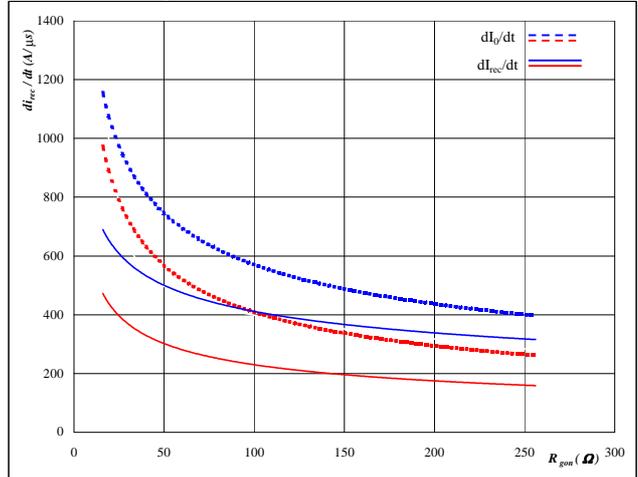


At  
 $T_j = 25/125$  °C  
 $V_{CE} = 300$  V  
 $V_{GE} = 15$  V  
 $R_{gon} = 32$  Ω

Figure 18 Output inverter FWD

Typical rate of fall of forward and reverse recovery current as a function of IGBT turn on gate resistor

$$dI_f/dt, dI_{rec}/dt = f(R_{gon})$$

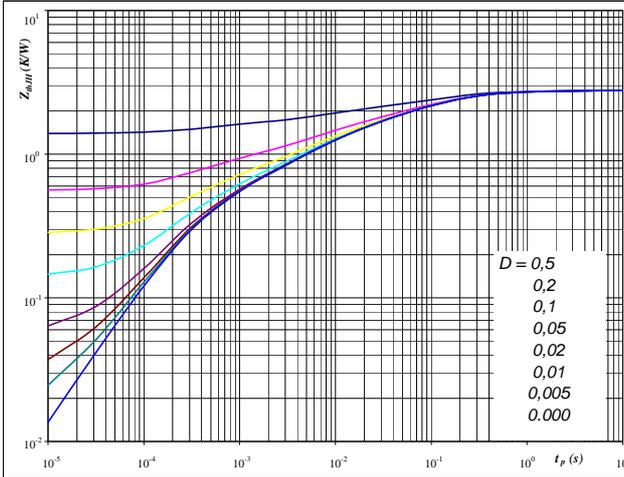


At  
 $T_j = 25/125$  °C  
 $V_R = 300$  V  
 $I_F = 6$  A  
 $V_{GE} = 15$  V

Figure 19 Output inverter IGBT

IGBT transient thermal impedance as a function of pulse width

$$Z_{thJH} = f(t_p)$$



At  
 $D = t_p / T$   
 $R_{thJH} = 2,78$  K/W

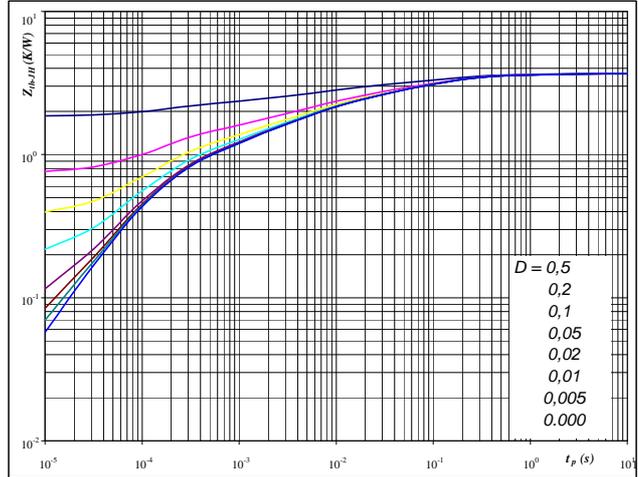
### IGBT thermal model values

Thermal grease		Phase change interface	
R (C/W)	Tau (s)	R (C/W)	Tau (s)
0,07	3,3E+00	0,06	2,7E+00
0,34	3,8E-01	0,27	3,1E-01
0,93	8,3E-02	0,75	6,7E-02
0,64	1,3E-02	0,52	1,1E-02
0,44	2,6E-03	0,36	2,1E-03
0,37	3,2E-04	0,30	2,6E-04

Figure 20 Output inverter FWD

FWD transient thermal impedance as a function of pulse width

$$Z_{thJH} = f(t_p)$$



At  
 $D = t_p / T$   
 $R_{thJH} = 3,68$  K/W

### FWD thermal model values

Thermal grease		Phase change interface	
R (C/W)	Tau (s)	R (C/W)	Tau (s)
0,04	1,4E+01	0,04	1,1E+01
0,20	7,0E-01	0,16	5,7E-01
0,88	1,2E-01	0,71	9,4E-02
0,69	2,0E-02	0,56	1,6E-02
0,78	4,1E-03	0,63	3,3E-03
0,44	7,3E-04	0,36	5,9E-04

## Output Inverter

**Figure 21** Output inverter IGBT

**Power dissipation as a function of heatsink temperature**

$P_{tot} = f(T_h)$

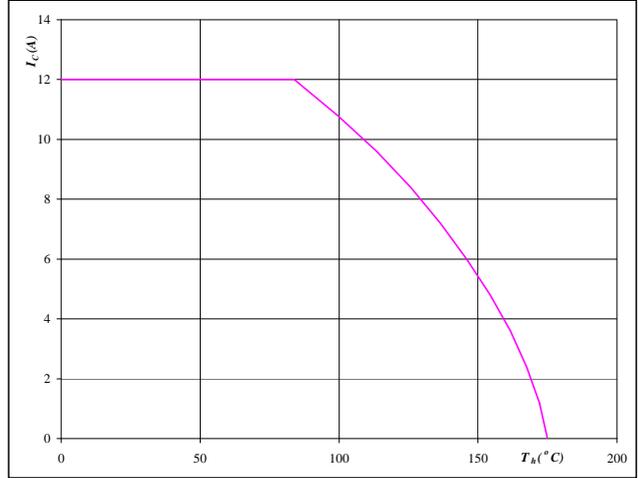


**At**  
 $T_j = 175 \text{ } ^\circ\text{C}$

**Figure 22** Output inverter IGBT

**Collector current as a function of heatsink temperature**

$I_C = f(T_h)$

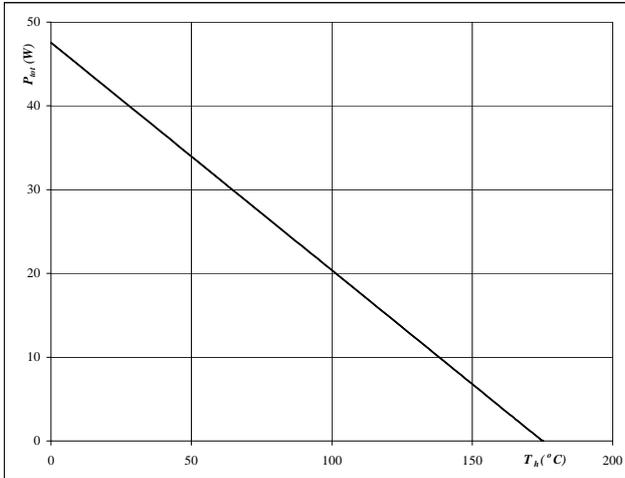


**At**  
 $T_j = 175 \text{ } ^\circ\text{C}$   
 $V_{GE} = 15 \text{ V}$

**Figure 23** Output inverter FWD

**Power dissipation as a function of heatsink temperature**

$P_{tot} = f(T_h)$

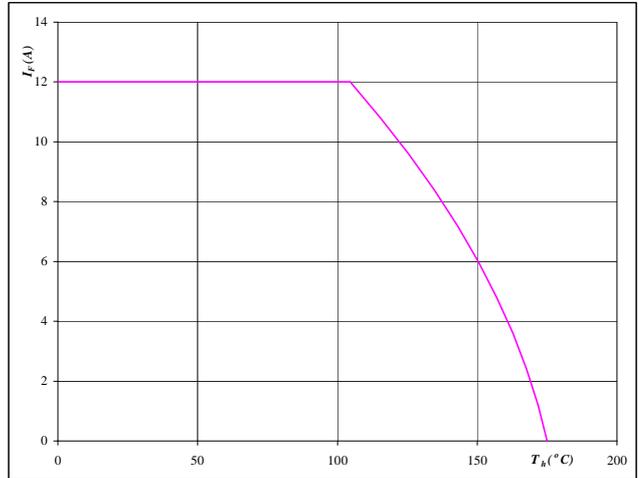


**At**  
 $T_j = 175 \text{ } ^\circ\text{C}$

**Figure 24** Output inverter FWD

**Forward current as a function of heatsink temperature**

$I_F = f(T_h)$

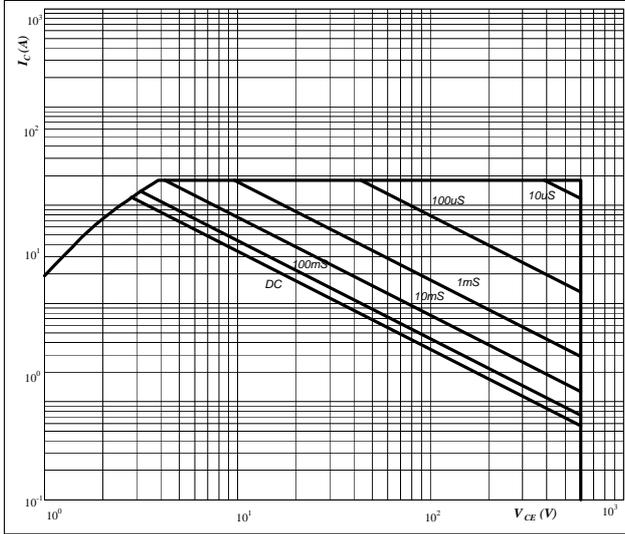


**At**  
 $T_j = 175 \text{ } ^\circ\text{C}$

## Output Inverter

Figure 25 Output inverter IGBT

Safe operating area as a function of collector-emitter voltage  
 $I_C = f(V_{CE})$

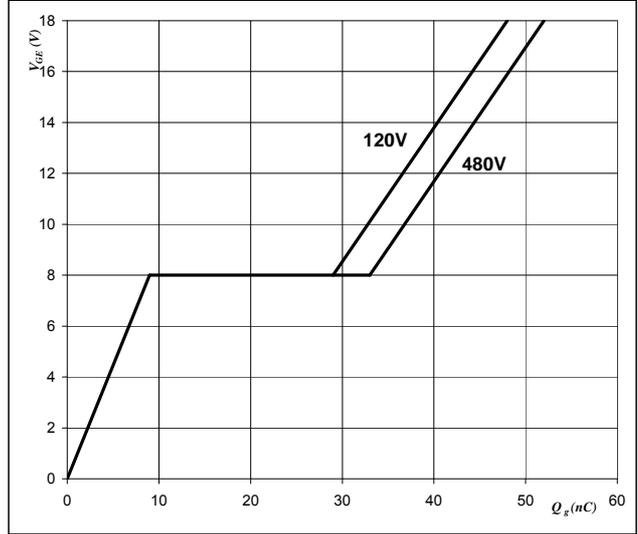


At  
 D = single pulse  
 $T_n = 80 \text{ } ^\circ\text{C}$   
 $V_{GE} = 15 \text{ V}$   
 $T_j = T_{jmax} \text{ } ^\circ\text{C}$

Figure 26 Output inverter IGBT

Gate voltage vs Gate charge

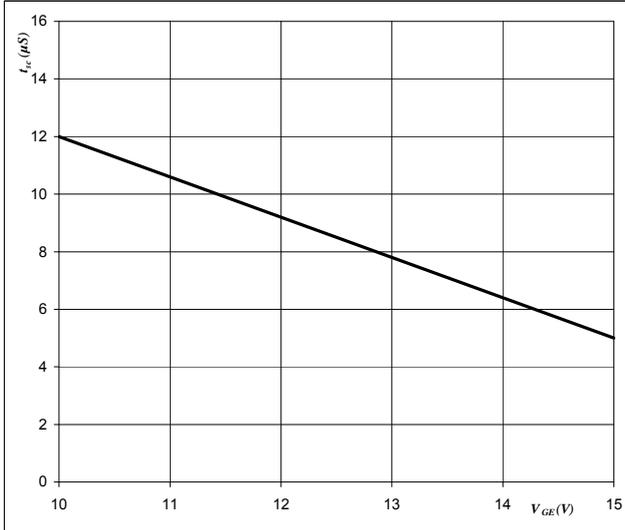
$V_{GE} = f(Q_g)$



At  
 $I_C = 6 \text{ A}$

Figure 27 Output inverter IGBT

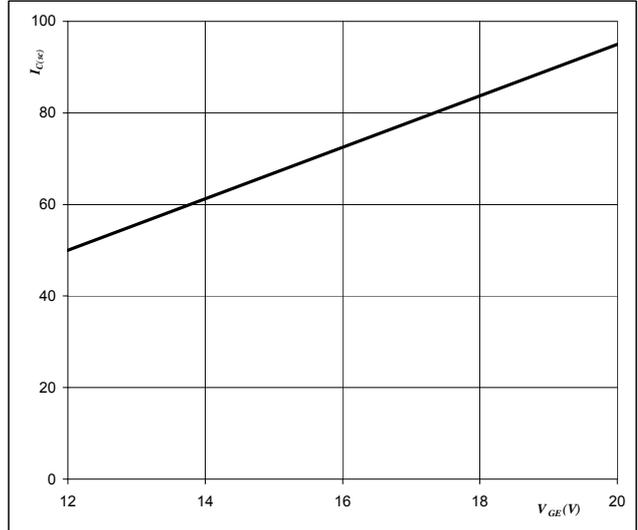
Short circuit withstand time as a function of gate-emitter voltage  
 $t_{sc} = f(V_{GE})$



At  
 $V_{CE} = 600 \text{ V}$   
 $T_j \leq 150 \text{ } ^\circ\text{C}$

Figure 28 Output inverter IGBT

Typical short circuit collector current as a function of gate-emitter voltage  
 $V_{GE} = f(Q_{GE})$

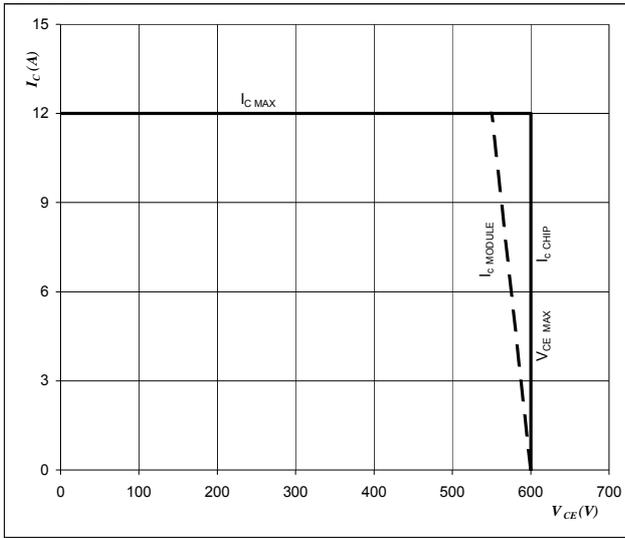


At  
 $V_{CE} \leq 400 \text{ V}$   
 $T_j = 150 \text{ } ^\circ\text{C}$

Figure 29 IGBT

Reverse bias safe operating area

$I_C = f(V_{CE})$



At

$T_J = T_{Jmax} - 25 \text{ } ^\circ\text{C}$

$U_{ocminus} = U_{ccplus}$

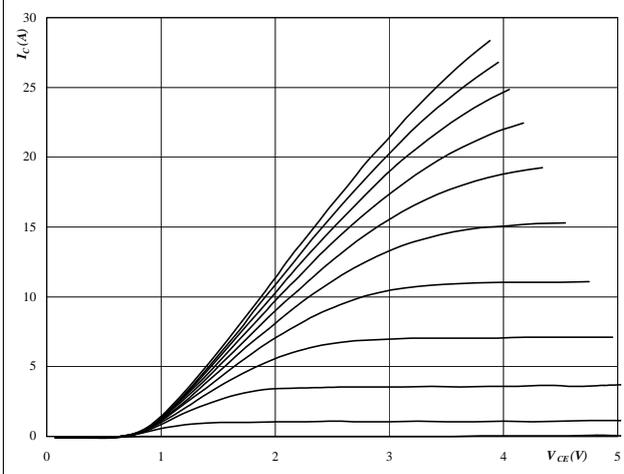
Switching mode : 3 level switching

## Brake

Figure 1 Brake IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

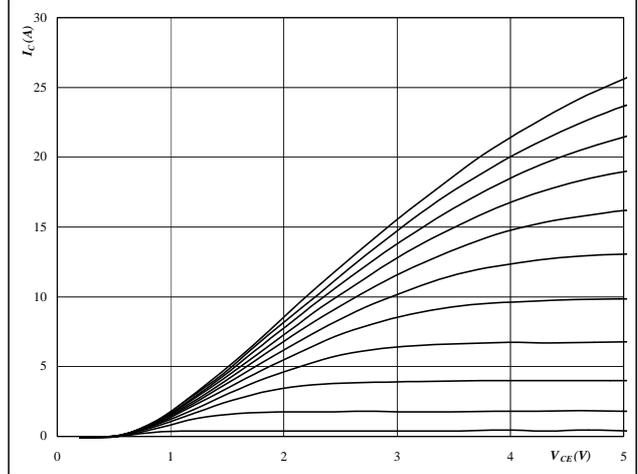


At  
 $t_p = 250 \mu s$   
 $T_J = 25 \text{ }^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

Figure 2 Brake IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

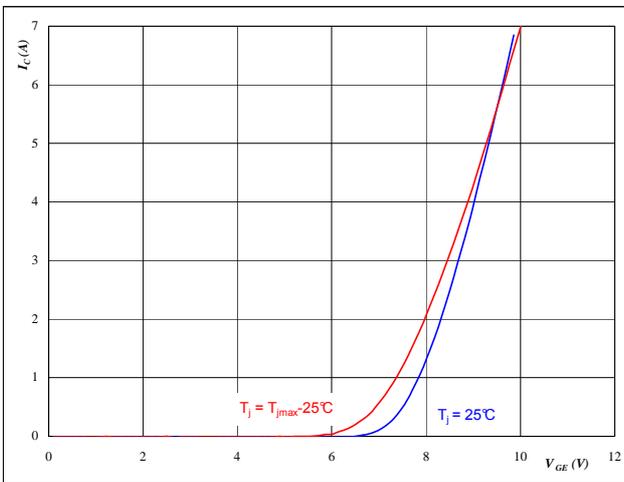


At  
 $t_p = 250 \mu s$   
 $T_J = 125 \text{ }^\circ C$   
 $V_{GE}$  from 7 V to 17 V in steps of 1 V

Figure 3 Brake IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

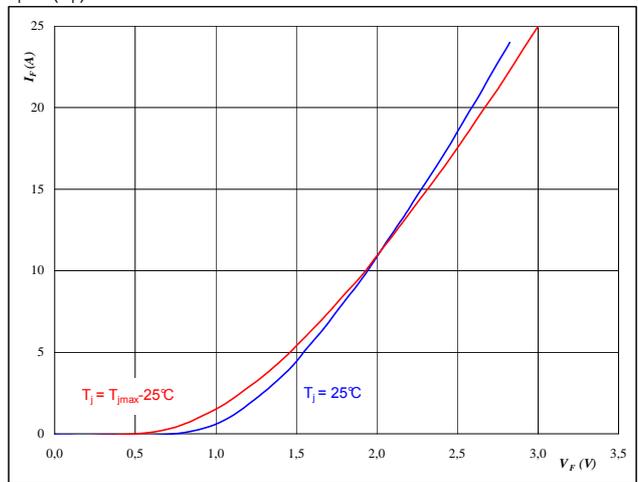


At  
 $t_p = 250 \mu s$   
 $V_{CE} = 10 V$

Figure 4 Brake FWD

Typical diode forward current as a function of forward voltage

$$I_F = f(V_F)$$



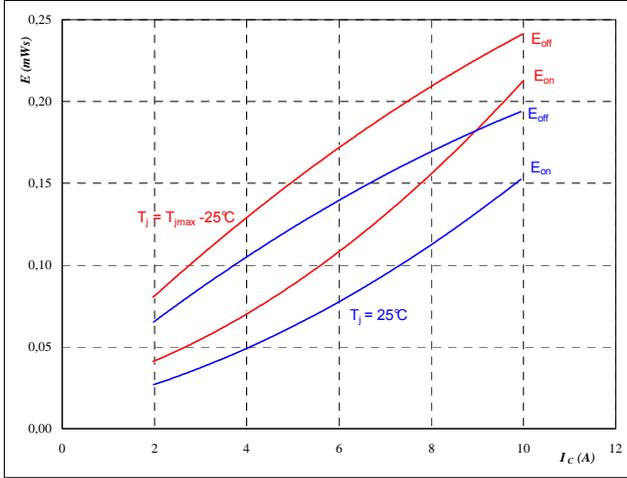
At  
 $t_p = 250 \mu s$

## Brake

Figure 5 Brake IGBT

Typical switching energy losses  
as a function of collector current

$E = f(I_C)$



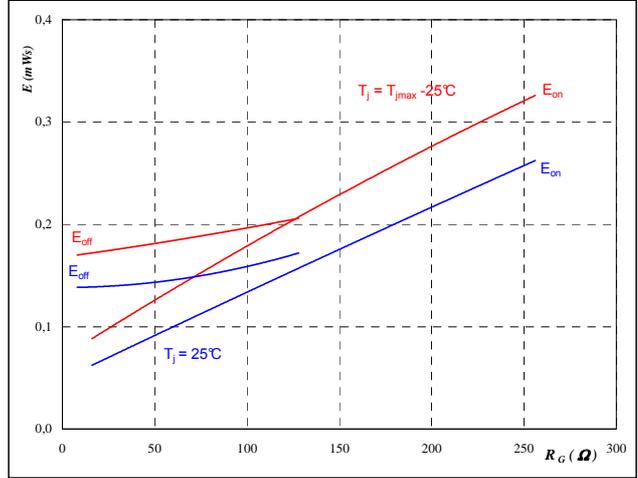
With an inductive load at

$T_j = 25/125$  °C  
 $V_{CE} = 300$  V  
 $V_{GE} = 15$  V  
 $R_{gon} = 32$  Ω  
 $R_{goff} = 16$  Ω

Figure 6 Brake IGBT

Typical switching energy losses  
as a function of gate resistor

$E = f(R_G)$



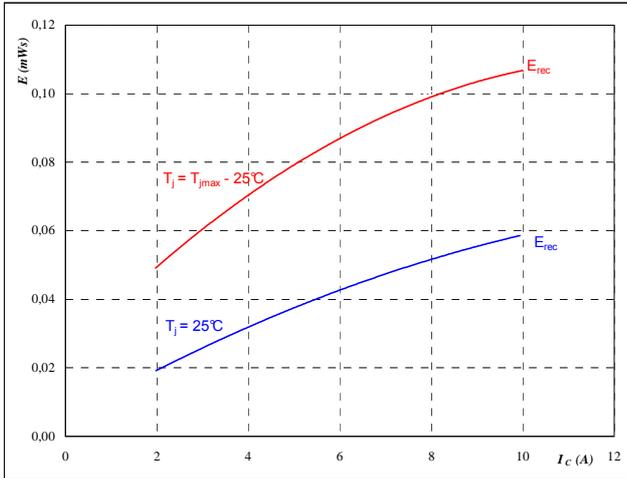
With an inductive load at

$T_j = 25/125$  °C  
 $V_{CE} = 300$  V  
 $V_{GE} = 15$  V  
 $I_C = 6$  A

Figure 7 Brake FWD

Typical reverse recovery energy loss  
as a function of collector current

$E_{rec} = f(I_C)$



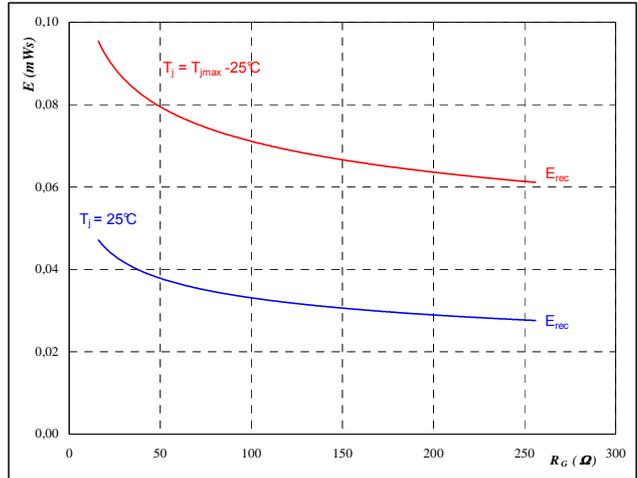
With an inductive load at

$T_j = 25/125$  °C  
 $V_{CE} = 300$  V  
 $V_{GE} = 15$  V  
 $R_{gon} = 32$  Ω

Figure 8 Brake FWD

Typical reverse recovery energy loss  
as a function of gate resistor

$E_{rec} = f(R_G)$



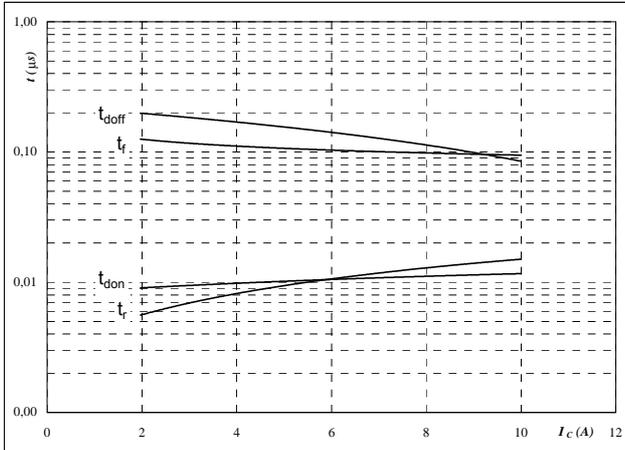
With an inductive load at

$T_j = 25/125$  °C  
 $V_{CE} = 300$  V  
 $V_{GE} = 15$  V  
 $I_C = 6$  A

## Brake

Figure 9 Brake IGBT

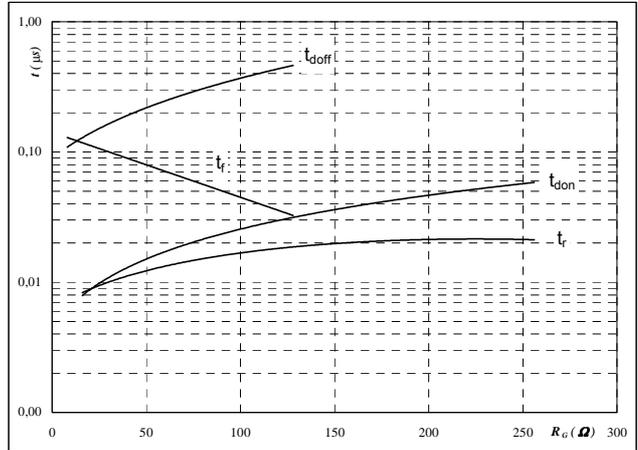
Typical switching times as a function of collector current  
 $t = f(I_C)$



With an inductive load at  
 $T_J = 25/125$  °C  
 $V_{CE} = 300$  V  
 $V_{GE} = 15$  V  
 $R_{gon} = 32$  Ω  
 $R_{goff} = 16$  Ω

Figure 10 Brake IGBT

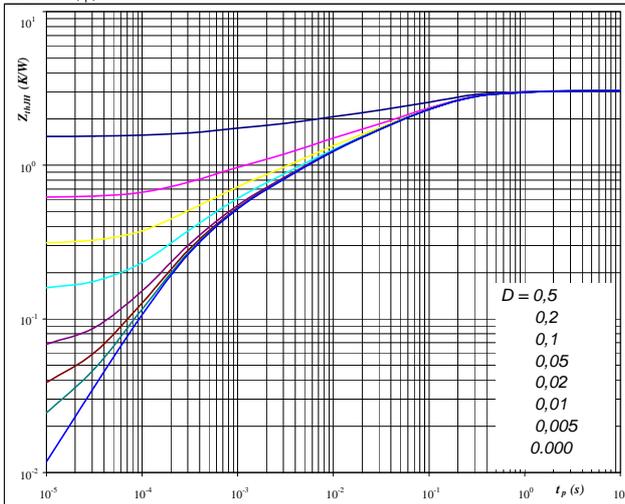
Typical switching times as a function of gate resistor  
 $t = f(R_G)$



With an inductive load at  
 $T_J = 25/125$  °C  
 $V_{CE} = 300$  V  
 $V_{GE} = 15$  V  
 $I_C = 6$  A

Figure 11 Brake IGBT

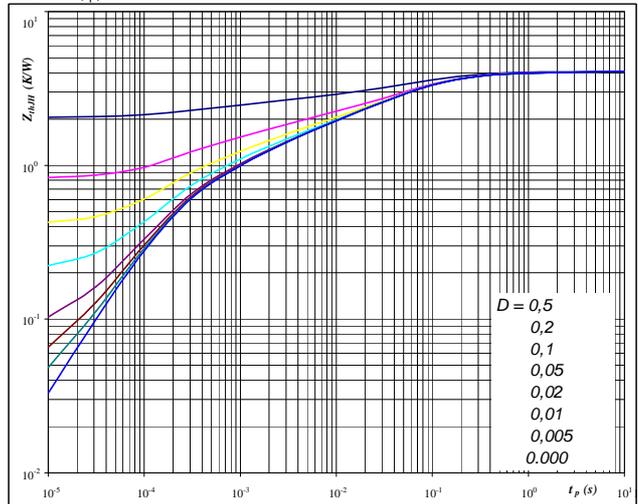
IGBT transient thermal impedance as a function of pulse width  
 $Z_{thJH} = f(t_p)$



At Thermal grease  $R_{thJH} = 3,063$  K/W  
 D =  $t_p / T$   
 Phase change interface  $R_{thJH} = 0,60$  K/W

Figure 12 Brake FWD

FWD transient thermal impedance as a function of pulse width  
 $Z_{thJH} = f(t_p)$



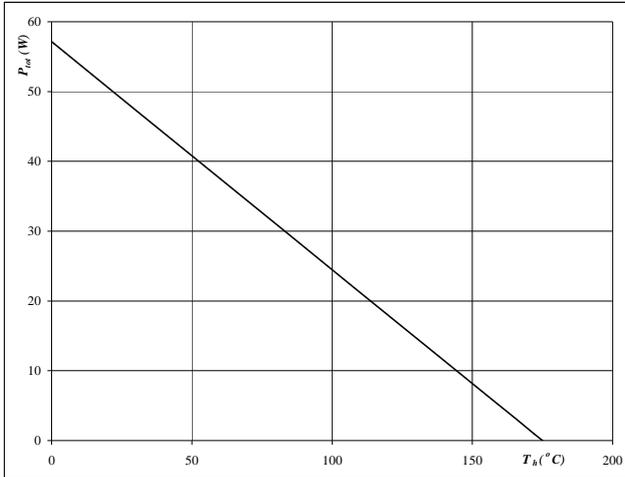
At Thermal grease  $R_{thJH} = 4,09$  K/W  
 D =  $t_p / T$   
 Phase change interface  $R_{thJH} = 1,27$  K/W

# Brake

**Figure 13** Brake IGBT

**Power dissipation as a function of heatsink temperature**

$P_{tot} = f(T_h)$

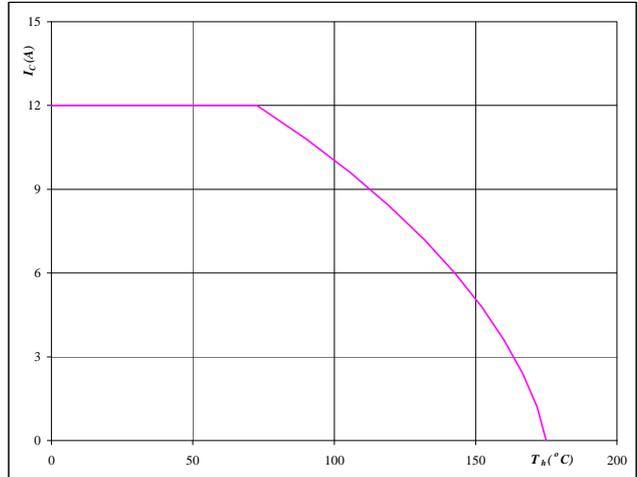


**At**  
 $T_j = 175 \text{ } ^\circ\text{C}$

**Figure 14** Brake IGBT

**Collector current as a function of heatsink temperature**

$I_C = f(T_h)$

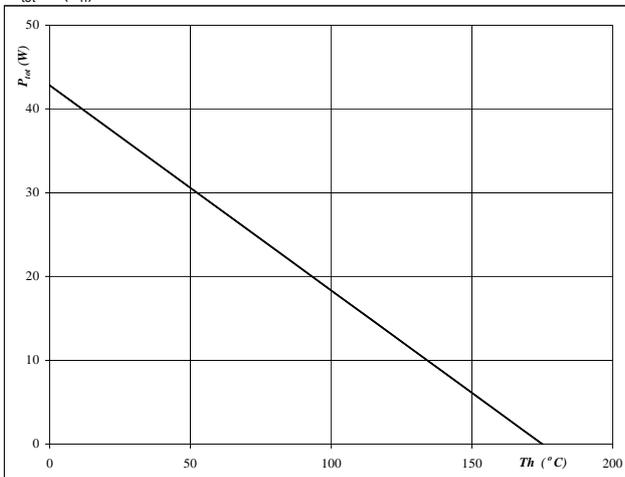


**At**  
 $T_j = 175 \text{ } ^\circ\text{C}$   
 $V_{GE} = 15 \text{ V}$

**Figure 15** Brake FWD

**Power dissipation as a function of heatsink temperature**

$P_{tot} = f(T_h)$

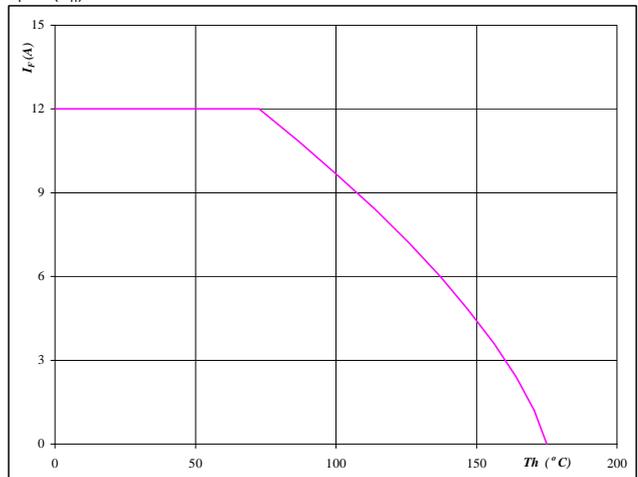


**At**  
 $T_j = 175 \text{ } ^\circ\text{C}$

**Figure 16** Brake FWD

**Forward current as a function of heatsink temperature**

$I_F = f(T_h)$



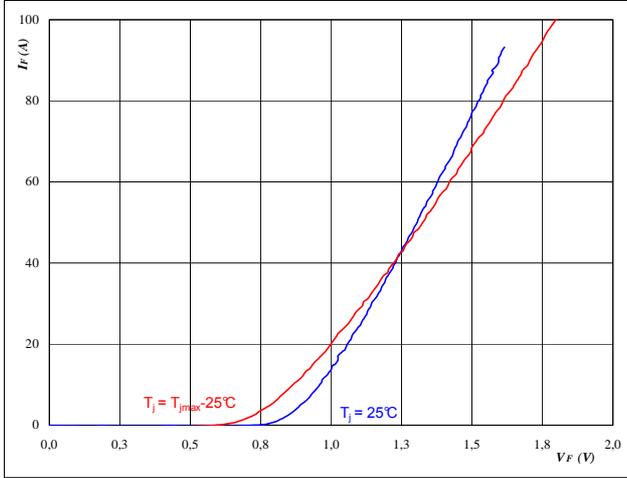
**At**  
 $T_j = 175 \text{ } ^\circ\text{C}$

# Input Rectifier Bridge

Figure 1 Rectifier diode

Typical diode forward current as a function of forward voltage

$I_F = f(V_F)$

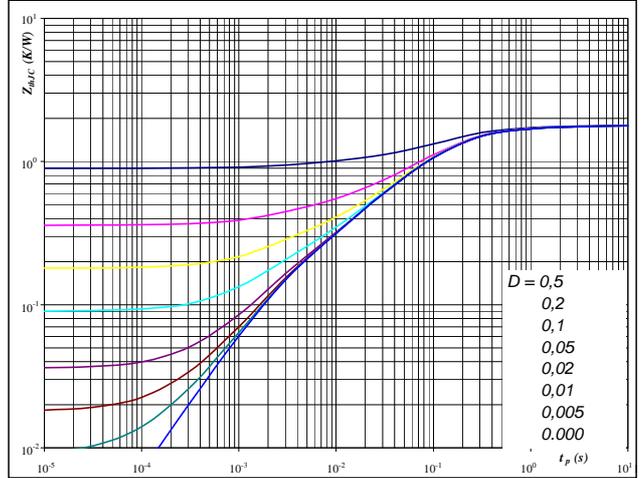


At  
 $t_p = 250 \mu s$

Figure 2 Rectifier diode

Diode transient thermal impedance as a function of pulse width

$Z_{thJH} = f(t_p)$

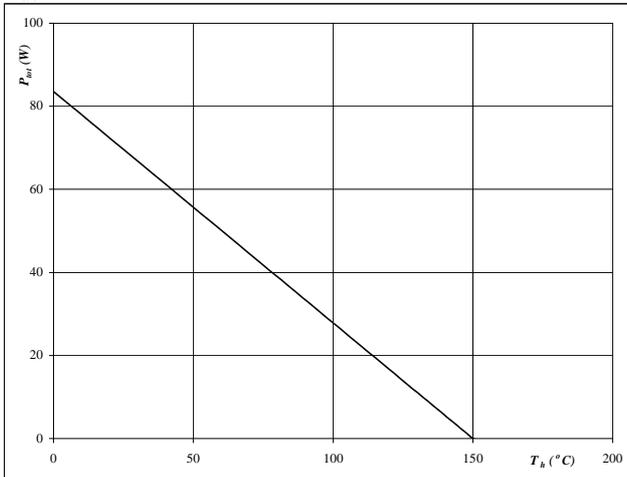


At  
 $D = t_p / T$   
 $R_{thJH} = 1,89 \text{ K/W}$

Figure 3 Rectifier diode

Power dissipation as a function of heatsink temperature

$P_{tot} = f(T_h)$

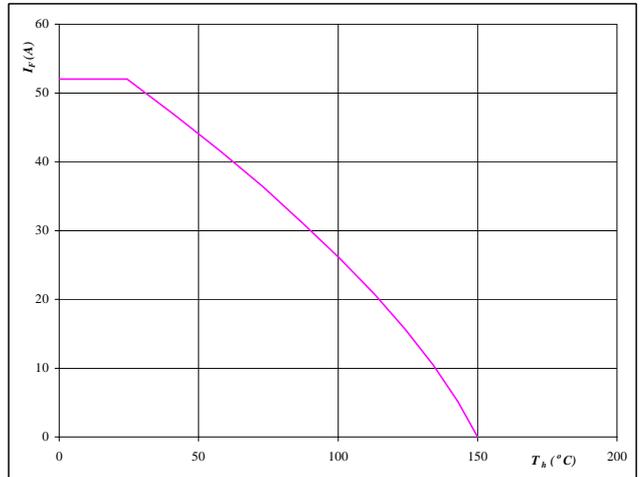


At  
 $T_j = 150 \text{ °C}$

Figure 4 Rectifier diode

Forward current as a function of heatsink temperature

$I_F = f(T_h)$



At  
 $T_j = 150 \text{ °C}$

## Thermistor

Figure 1 Thermistor

Typical NTC characteristic  
as a function of temperature

$$R_T = f(T)$$

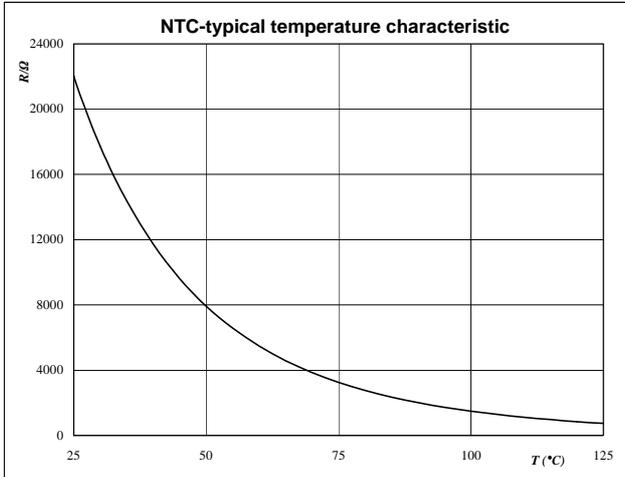


Figure 2 Thermistor

Typical NTC resistance values

$$R(T) = R_{25} \cdot e^{\left( B_{25/100} \left( \frac{1}{T} - \frac{1}{T_{25}} \right) \right)} \quad [\Omega]$$

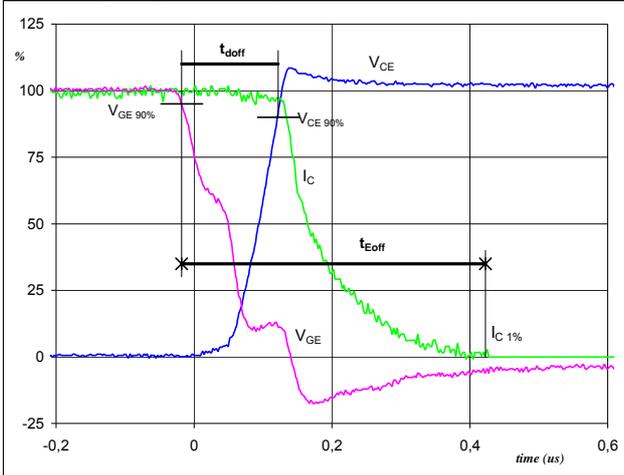
T [°C]	R <sub>nom</sub> [Ω]	R <sub>min</sub> [Ω]	R <sub>max</sub> [Ω]	ΔR/R [±%]
-55	2089434,5	1506495,4	2672373,6	27,9
0	71804,2	59724,4	83884	16,8
10	43780,4	37094,4	50466,5	15,3
20	27484,6	23684,6	31284,7	13,8
25	22000	19109,3	24890,7	13,1
30	17723,3	15512,2	19934,4	12,5
60	5467,9	4980,6	5955,1	8,9
70	3848,6	3546	4151,1	7,9
80	2757,7	2568,2	2947,1	6,9
90	2008,9	1889,7	2128,2	5,9
<b>100</b>	<b>1486,1</b>	<b>1411,8</b>	<b>1560,4</b>	<b>5</b>
150	400,2	364,8	435,7	8,8

## Switching Definitions Output Inverter

General conditions	
$T_j$	= 125 °C
$R_{gon}$	= 32 Ω
$R_{goff}$	= 16 Ω

Figure 1 Output inverter IGBT

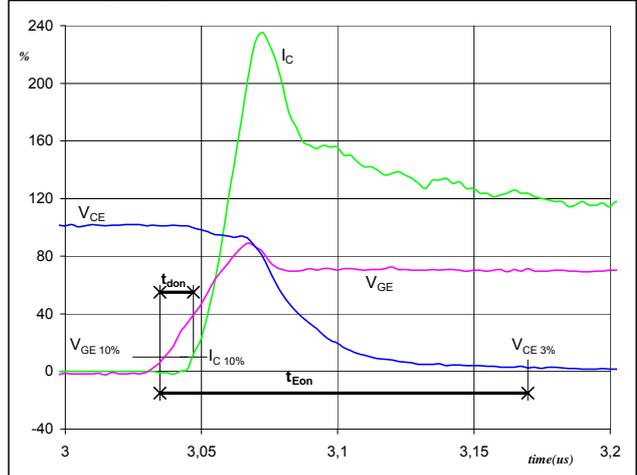
Turn-off Switching Waveforms & definition of  $t_{doff}$ ,  $t_{Eoff}$   
 ( $t_{Eoff}$  = integrating time for  $E_{off}$ )



$V_{GE}(0\%) =$	0	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	300	V
$I_C(100\%) =$	6	A
$t_{doff} =$	0,13	μs
$t_{Eoff} =$	0,44	μs

Figure 2 Output inverter IGBT

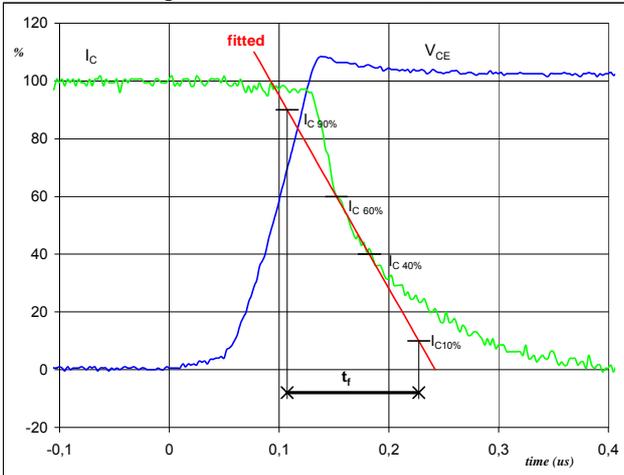
Turn-on Switching Waveforms & definition of  $t_{don}$ ,  $t_{Eon}$   
 ( $t_{Eon}$  = integrating time for  $E_{on}$ )



$V_{GE}(0\%) =$	0	V
$V_{GE}(100\%) =$	15	V
$V_C(100\%) =$	300	V
$I_C(100\%) =$	6	A
$t_{don} =$	0,01	μs
$t_{Eon} =$	0,13	μs

Figure 3 Output inverter IGBT

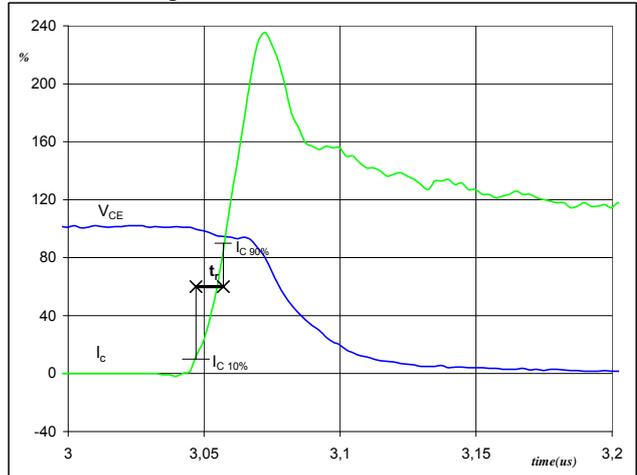
Turn-off Switching Waveforms & definition of  $t_f$



$V_C(100\%) =$	300	V
$I_C(100\%) =$	6	A
$t_f =$	0,12	μs

Figure 4 Output inverter IGBT

Turn-on Switching Waveforms & definition of  $t_f$

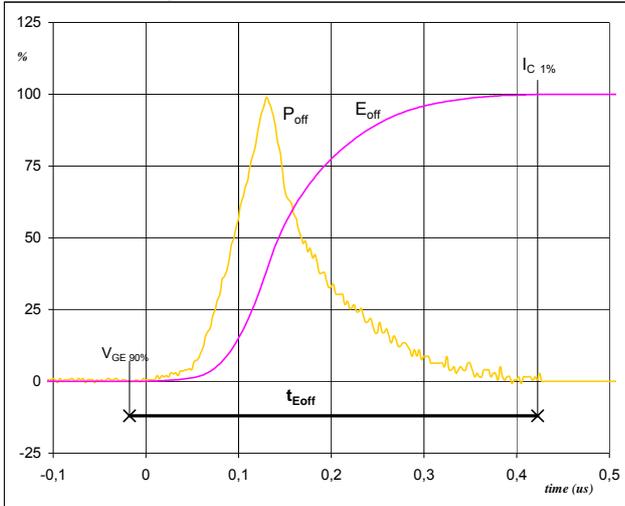


$V_C(100\%) =$	300	V
$I_C(100\%) =$	6	A
$t_f =$	0,01	μs

## Switching Definitions Output Inverter

**Figure 5** Output inverter IGBT

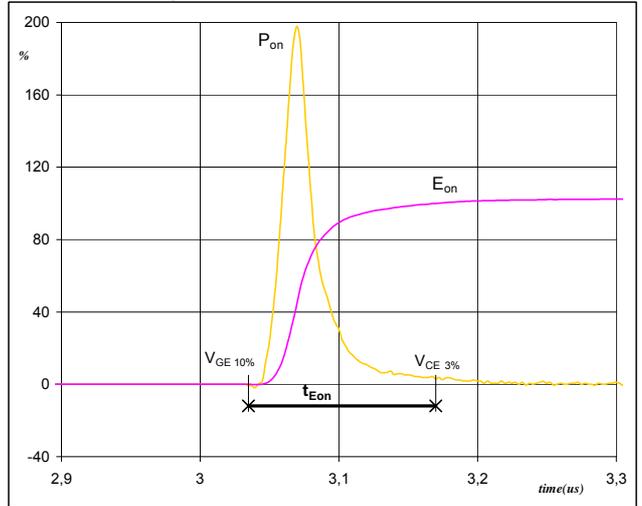
**Turn-off Switching Waveforms & definition of  $t_{Eoff}$**



$P_{off} (100\%) = 1,79 \text{ kW}$   
 $E_{off} (100\%) = 0,19 \text{ mJ}$   
 $t_{Eoff} = 0,44 \text{ }\mu\text{s}$

**Figure 6** Output inverter IGBT

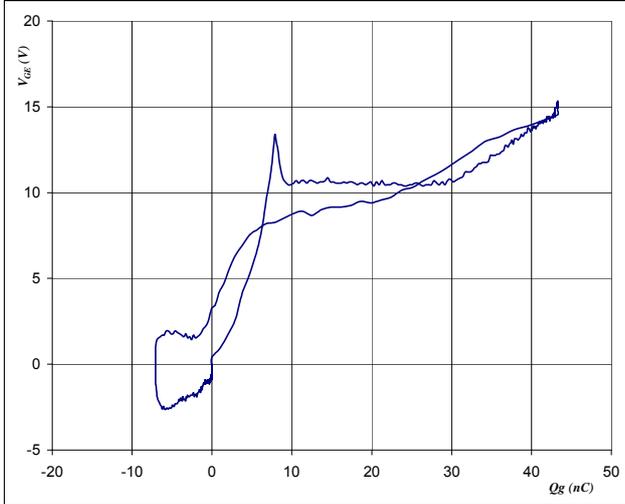
**Turn-on Switching Waveforms & definition of  $t_{Eon}$**



$P_{on} (100\%) = 1,79 \text{ kW}$   
 $E_{on} (100\%) = 0,10 \text{ mJ}$   
 $t_{Eon} = 0,13 \text{ }\mu\text{s}$

**Figure 7** Output inverter FWD

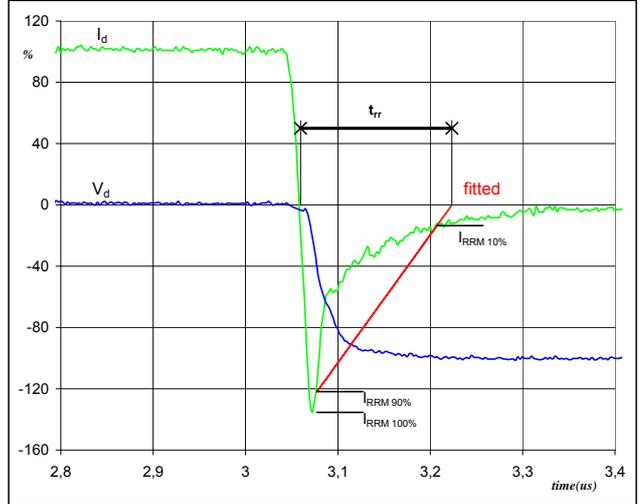
**Gate voltage vs Gate charge (measured)**



$V_{GEoff} = 0 \text{ V}$   
 $V_{GEon} = 15 \text{ V}$   
 $V_C (100\%) = 300 \text{ V}$   
 $I_C (100\%) = 6 \text{ A}$   
 $Q_g = 43,26 \text{ nC}$

**Figure 8** Output inverter IGBT

**Turn-off Switching Waveforms & definition of  $t_{rr}$**

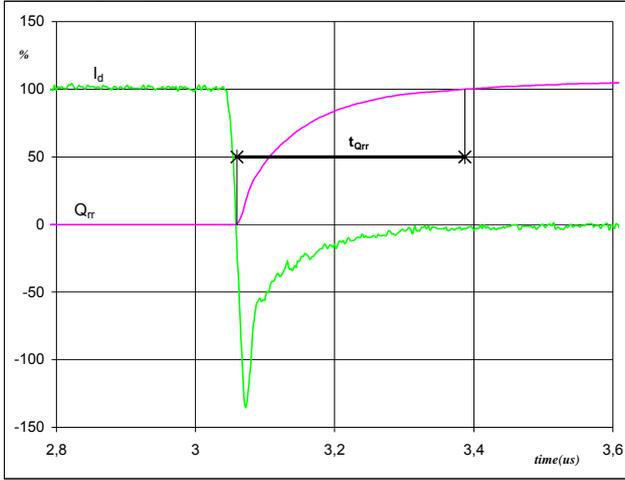


$V_d (100\%) = 300 \text{ V}$   
 $I_d (100\%) = 6 \text{ A}$   
 $I_{RRM} (100\%) = 8 \text{ A}$   
 $t_{rr} = 0,16 \text{ }\mu\text{s}$

## Switching Definitions Output Inverter

Figure 9 Output inverter FWD

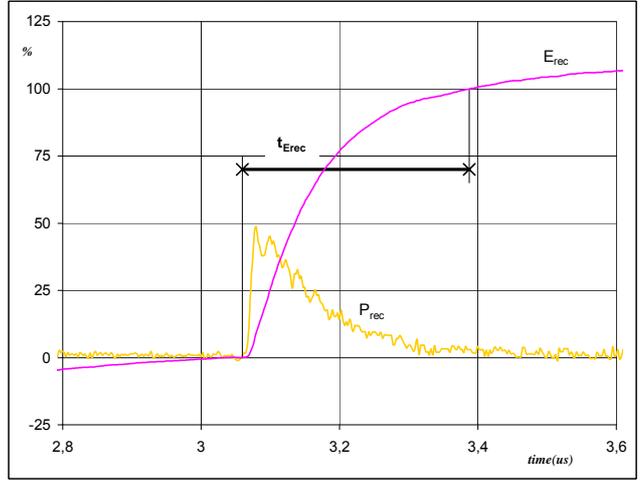
Turn-on Switching Waveforms & definition of  $t_{Qrr}$   
 ( $t_{Qrr}$  = integrating time for  $Q_{rr}$ )



$I_d$  (100%) = 6 A  
 $Q_{rr}$  (100%) = 0,43  $\mu$ C  
 $t_{Qrr}$  = 0,33  $\mu$ s

Figure 10 Output inverter FWD

Turn-on Switching Waveforms & definition of  $t_{Erec}$   
 ( $t_{Erec}$  = integrating time for  $E_{rec}$ )



$P_{rec}$  (100%) = 1,79 kW  
 $E_{rec}$  (100%) = 0,09 mJ  
 $t_{Erec}$  = 0,33  $\mu$ s

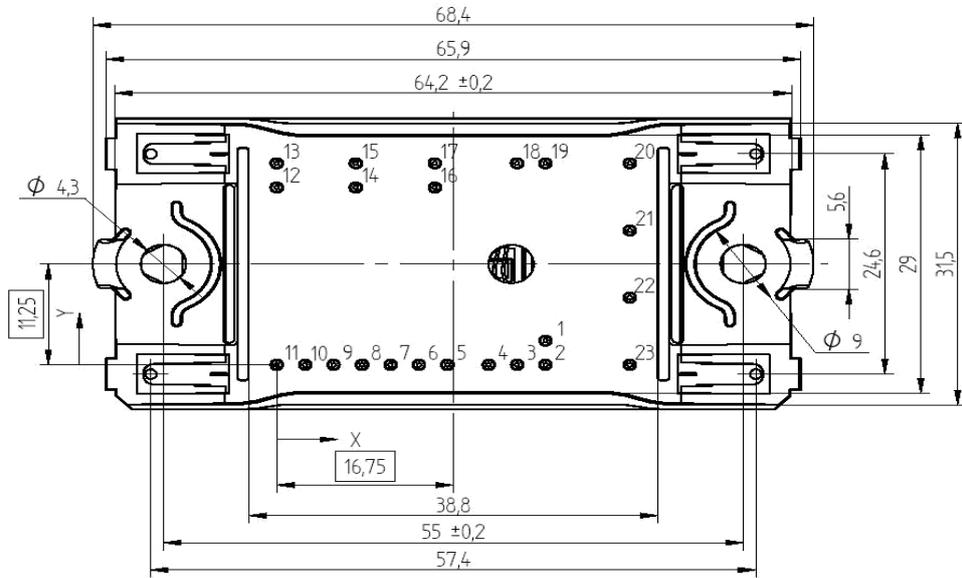
## Ordering Code and Marking - Features - Outline - Pinout

### Ordering Code & Marking

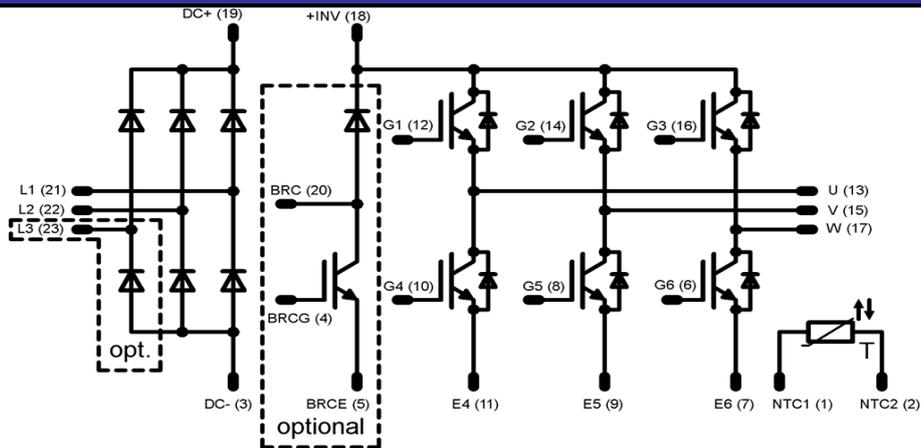
Version	Ordering Code	in DataMatrix as	in packaging barcode as
without thermal paste 12mm housing	V23990-P541-A38-PM	P541-A38-PM	P541-A38
without thermal paste 17mm housing	V23990-P541-A39-PM	P541-A39-PM	P541-A39
without thermal paste 12mm housing	V23990-P541-C38-PM	P541-C38-PM	P541-C38
without thermal paste 17mm housing	V23990-P541-C39-PM	P541-C39-PM	P541-C39

### Outline

Pin Table		
Pin	X	Y
1	25.5	2.7
2	25.5	0
3	22.8	0
4	20.1	0
5	16.2	0
6	13.5	0
7	10.8	0
8	8.1	0
9	5.4	0
10	2.7	0
11	0	0
12	0	19.8
13	0	22.5
14	7.5	19.8
15	7.5	22.5
16	15	19.8
17	15	22.5
18	22.8	22.5
19	25.5	22.5
20	33.5	22.5
21	33.5	15
22	33.5	7.5
23	33.5	0



### Pinout



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